

RoHS

COMPLIANT

HALOGEN

Available

Vishay Siliconix

# N-Channel 30-V (D-S) MOSFET with Schottky Diode

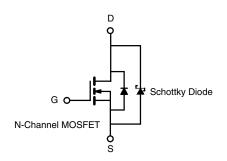
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}$ (Ω) $I_{D}$ (A) <sup>a</sup> Q		Q <sub>g</sub> (Typ.)		
30	0.00375 at V <sub>GS</sub> = 10 V	34	35.7 nC		
30	0.0047 at $V_{GS}$ = 4.5 V	30	33.7 110		

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Available
- SkyFET<sup>®</sup> Monolithic TrenchFET<sup>®</sup> Power MOSFET and Schottky Diode
- 100 % R<sub>g</sub> and UIS Tested

#### **APPLICATIONS**

- Notebook CPU Core
- Buck Converter
- Synchronous Rectifier Switch



	SO-8	
S 1		8 D
S 2		7 D
S 3		6 D
G 4		5 D
	Top View	

Ordering Information: Si4642DY-T1-E3 (Lead (Pb)-free) Si4642DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		34	А	
	T <sub>C</sub> = 70 °C	Ι <sub>D</sub>	27		
	T <sub>A</sub> = 25 °C		22.7 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		18 <sup>b, c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	70	А	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	. I <sub>S</sub>	7		
Continuous Source-Drain Diode Ourient	T <sub>A</sub> = 25 °C	'S	3.1 <sup>b, c</sup>		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	45		
Single Pulse Avalanche Energy	L = 0.1 IIII1	E <sub>AS</sub>	101	mJ	
	T <sub>C</sub> = 25 °C		7.8		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	5	w	
	T <sub>A</sub> = 25 °C	·D	3.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		2.2 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Тур.	Max.	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	29	35	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	13	16	0/11	

Notes:

a. Based on  $T_C = 25$  °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 80 °C/W.

## Si4642DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					I		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 1 mA$	30			V	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1.5		3	v	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		± 100	nA	
Zero Gate Voltage Drain Current	I	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		0.05	0.2	mA	
	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 100 ^{\circ}\text{C}$		5.5	50		
On -State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq 5 \text{ V},  V_{GS} = 10 \text{ V}$	40			А	
	D	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0031	0.00375	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		0.0039	0.0047		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A		108		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			5540		pF	
Output Capacitance	Coss	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		790			
Reverse Transfer Capacitance	C <sub>rss</sub>			346			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		74	110	nC	
				35.7	54		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		16.8			
Gate-Drain Charge	Q <sub>gd</sub>			10.7			
Gate Resistance	Rg	f = 1 MHz		1.5	2.3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			76	115		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3 $\Omega$		180	270		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_G = 1 \Omega$		53	80		
Fall Time	t <sub>f</sub>			50	75		
Turn-On Delay Time	t <sub>d(on)</sub>			17	26	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 3 $\Omega$		24	36		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 5$ A, $V_{GEN}$ = 10 V, $R_G$ = 1 $\Omega$		46	70		
Fall Time	t <sub>f</sub>	]		9	15		
Drain-Source Body Diode and Schottky	Characterist			-			
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C			7	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				70	A	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 2 A		0.44	0.53	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			36	55	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 13 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		34	52	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$-1_{\rm F} - 10$ A, $u/u_{\rm I} = 100$ A/µs, $1_{\rm J} = 25^{\circ}$ C -		19		ns	
Reverse Recovery Rise Time	t <sub>b</sub>	1 1		17	İ		

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

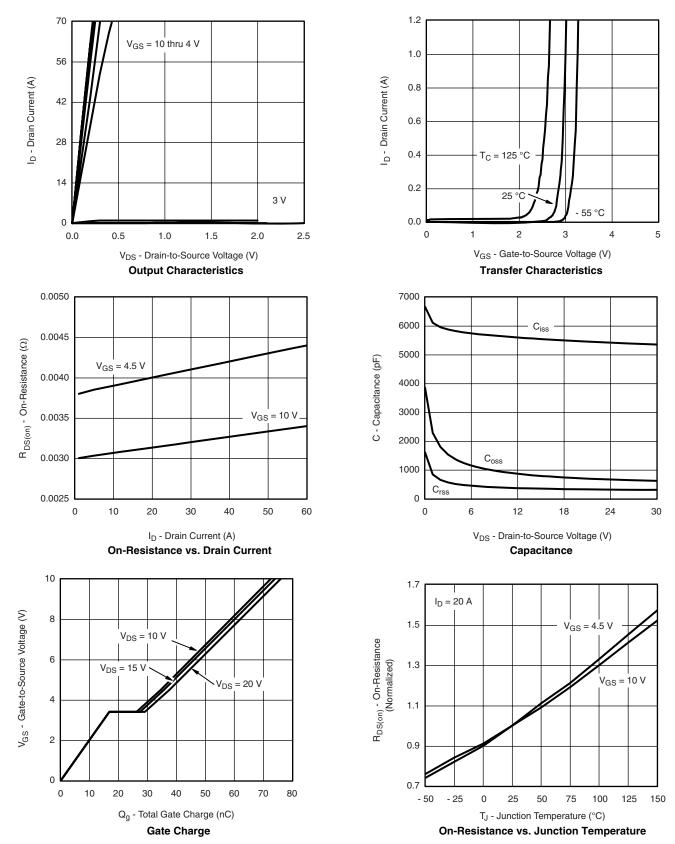
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



# Si4642DY

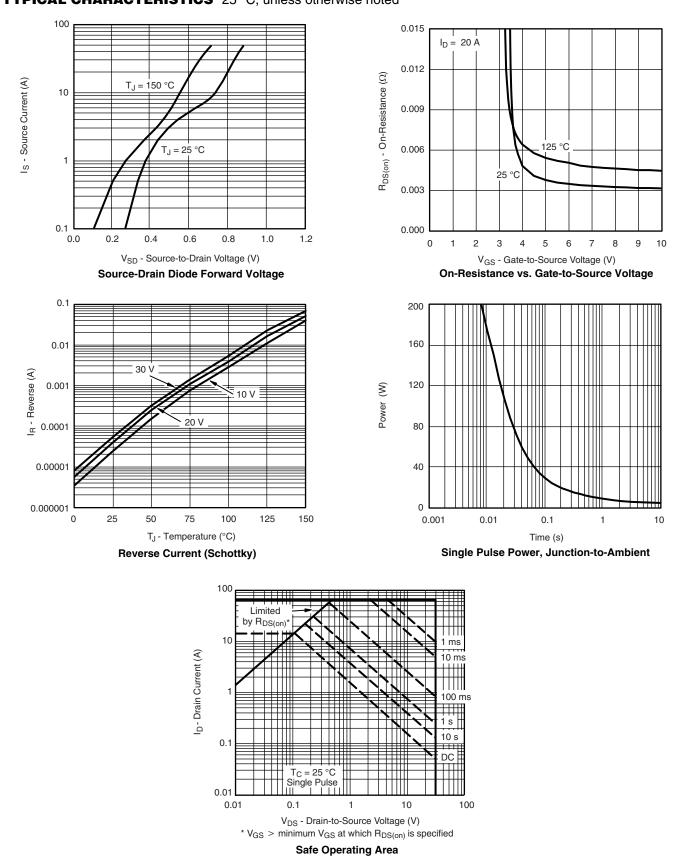
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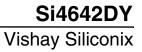
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Document Number: 74430 S09-0138-Rev. B, 02-Feb-09 Vishay Siliconix

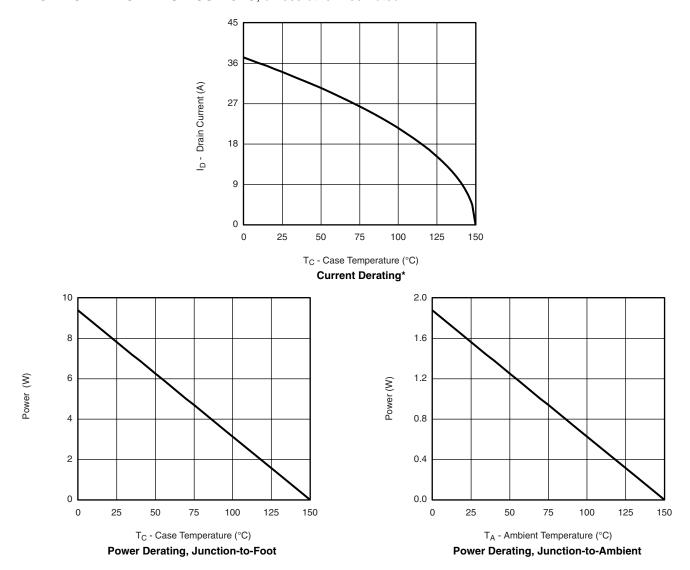
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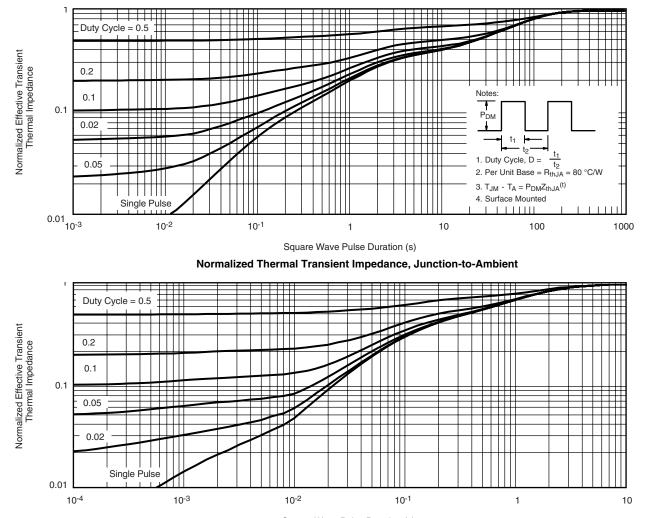
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\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Foot

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